CY7C3381A
CY7C3382A

UltraLogic™ 3.3V High Speed 1K Gate CMOS FPGA

Features

- Very high speed
  - Loadable counter frequencies greater than 80 MHz
  - Chip-to-chip operating frequencies up to 60 MHz
- Unparalleled FPGA performance for counters, data path, state machines, arithmetic, and random logic
- Low power
  - Standby current typically 250 µA
  - 16-bit counter operating at 80 MHz consumes 20 mA
- High usable density
  - 8 x 12 array of 96 logic cells provides 3,000 total available gates
  - 1,000 typically usable "gate array" gates in 44- and 68-pin PLCC and 100-pin TQFP packages
- Fully PCI compliant inputs and outputs for commercial and industrial temperature range
- Flexible logic cell architecture
  - Wide fan-in (up to 14 input gates)
  - Multiple outputs in each cell
  - Very low cell propagation delay (1.7ns typical)
- Powerful design tools—*Warp3*™
  - Designs entered in VHDL, schematics, or both
  - Fast, fully automatic place and route
  - Waveform simulation with back-annotated net delays
  - PC and workstation platforms
- Extensive 3rd party tool support
  - See Development Systems section
- 5V Tolerant Inputs (see I_{IH} spec)
- Robust routing resources
  - Fully automatic place and route of designs using up to 100 percent of logic resources
  - No hand routing required
- 32 (CY7C3381A) to 56 (CY7C3382A) bidirectional input/output pins
- 6 dedicated input/high-drive pins
- 2 clock/dedicated input pins with fan-out-independent, low-skew nets
  - Clock skew <0.5 ns
- Input hysteresis provides high noise immunity
- Thorough testability at 3.3V
  - Built-in scan path permits 100 percent factory testing of logic and I/O cells
- 0.65µ CMOS process with ViaLink™ programming technology
  - High-speed metal-to-metal link
  - Non-volatile antifuse technology
- 68-pin PLCC is pinout compatible with 2K (CY7C3384A) devices
- 100-pin TQFP is pinout compatible with 3.3V 2K (CY7C3384A) and 4K (CY7C3385A) devices
- Pinout compatible with 5V CY7C381P/2P devices

Functional Description

The CY7C3381A and CY7C3382A are 3.3V very high speed CMOS user-programmable ASIC (pASIC™) devices. The 96 logic cell field-programmable gate array (FPGA) offers 1,000 typically usable "gate array" gates. This is equivalent to 3,000 EPLD or LCA gates. The CY7C3381A is available in a 44-pin PLCC package. The CY7C3382A is available in a 68-pin PLCC and a 100-pin TQFP package.

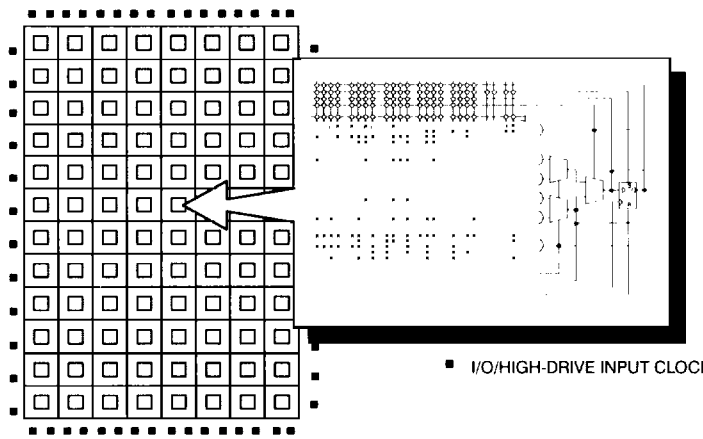
Low-impedance, metal-to-metal ViaLink interconnect technology provides non-volatile custom logic capable of operating at speeds above 100 MHz. This permits high-density programmable devices to be used with today's fastest CISC and RISC microprocessors.

Designs are entered into the CY7C3381A and CY7C3382A using Cypress *Warp3* software or one of several third-party tools. See the Development Systems section of the *Programmable Logic Databook* for more tools information.

Warp3 is a sophisticated CAE package that features schematic entry, waveform-based timing simulation, and VHDL design synthesis. The CY7C3381A and CY7C3382A feature ample on-chip routing channels for fast, fully automatic place and route of high gate utilization designs.

For detailed information about the pASIC3380 architecture, see the pASIC380 Family datasheet.

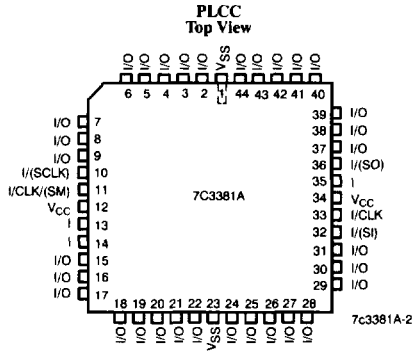
Logic Block Diagram



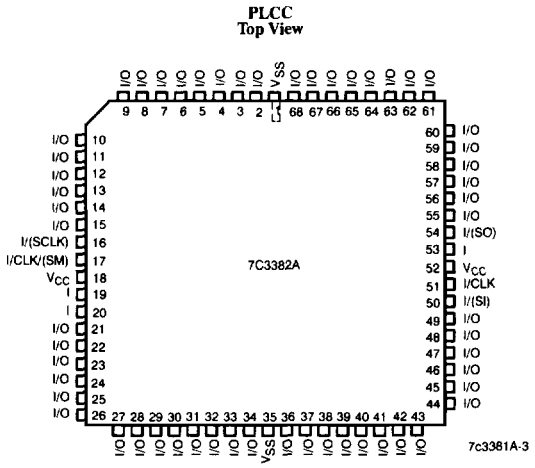
44, 68, or 100 PINS, INCLUDING 56 I/O CELLS, 6 INPUT HIGH-DRIVE CELLS, 2 INPUT/CLK (HIGH-DRIVE) CELLS

Pin Configurations

PLCC
Top View

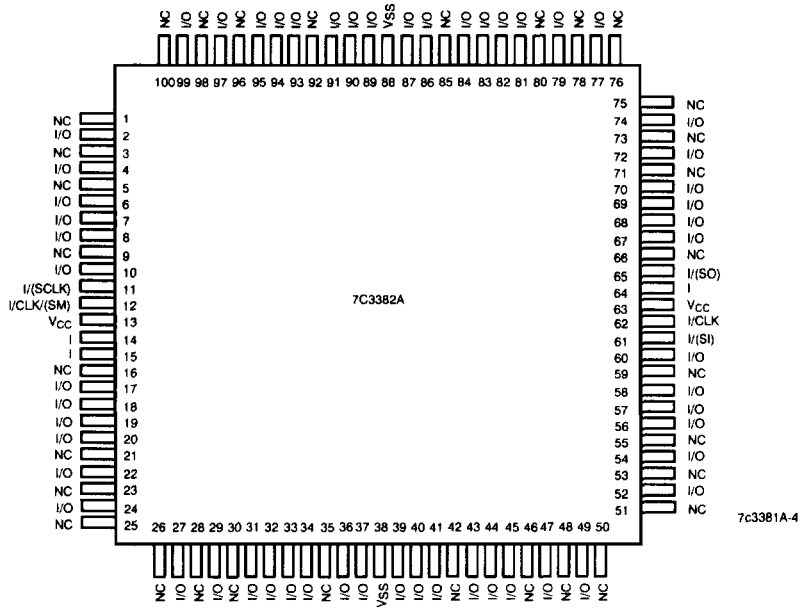


PLCC
Top View



4

TQFP
Top View



Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature
Ceramic ..... − 65°C to +150°C
Plastic ..... −40°C to +125°C

Lead Temperature ..... 300°C

Supply Voltage ..... − 0.5V to +7.0V

Input Voltage ..... − 0.5V to V_{CC} +0.7V

ESD Pad Protection ..... ±2000 V

DC Input Voltage ..... −0.5V to 7.0V

DC Input Current ..... ±20 mA

Latch-Up Current ..... ±200 mA

Operating Range

Range	Ambient Temperature	V_{CC}
Commercial	0°C to +70°C	3.3V ± 0.3V
Industrial	−40°C to +85°C	3.3V ± 0.3V

Delay Factor (K)

Speed Grade	Commercial		Industrial	
	Min.	Max.	Min.	Max.
−X	0.46	3.52	0.40	3.77
−0	0.46	2.61	0.40	2.81
−1	0.46	2.23	0.40	2.39

Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	I_{OH} = −2.4 mA	2.4		V
		I_{OH} = −10.0 µA	V_{CC} − 0.1		V
V_{OL}	Output LOW Voltage	I_{OL} = 4.0 mA		0.4	V
		I_{OL} = 10.0 µA		0.1	V
V_{IH}	Input HIGH Voltage		2.0		V
V_{IL}	Input LOW Voltage			0.8	V
I_{IH}	Input HIGH Current Sink (For 5V Inputs)	5V > V_{IN} > V_{CC}		12[1]	mA
I_I	Input Leakage Current	V_{IN} = V_{CC} or V_{SS}	−10	+10	µA
I_{OZ}	Output Leakage Current Three-State	V_{IN} = V_{CC} or V_{SS}	−10	+10	µA
I_{OS}	Output Short Circuit Current[2]	V_{OUT} = V_{SS}	−5	−50	mA
		V_{OUT} = V_{CC}	5	100	mA
I_{CC1}	Standby Supply Current	V_{IN}, $V_{I/O}$ = V_{CC} or V_{SS}		650	µA

Capacitance

Parameter	Description	Test Conditions	Max.	Unit
C_{IN}	Input Capacitance[3]	T_A = 25°C, f = 1 MHz, V_{CC} = 3.3V	10	pF
C_{OUT}	Output Capacitance		10	pF

Note:
1. User must limit input current to 12 mA.
2. Only one output at a time. Duration should not exceed 30 seconds.
3. C_I = 20 pF max. on I/(SI).

Switching Characteristics (V_{CC}=3.3 V, T_A=25 °C, K=1.00)

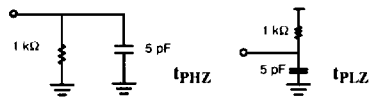
Parameter	Description	Propagation Delays[4] with Fanout of 1	2	3	4	8	Unit
LOGIC CELLS							
t_{PD}	Combinatorial Delay[5]	1.7	2.1	2.7	3.3	4.8	ns
t_{SU}	Set-Up Time[5]	2.1	2.1	2.1	2.1	2.1	ns
t_H	Hold Time	0.0	0.0	0.0	0.0	0.0	ns
t_{CLK}	Clock to Q Delay	1.0	1.5	1.9	2.3	4.2	ns
t_{CWHI}	Clock HIGH Time	2.0	2.0	2.0	2.0	2.0	ns
t_{CWLO}	Clock LOW Time	2.0	2.0	2.0	2.0	2.0	ns
t_{SET}	Set Delay	1.7	2.2	2.7	3.0	4.8	ns
t_{RESET}	Reset Delay	1.5	1.8	2.2	2.5	3.9	ns
t_{SW}	Set Width	1.9	1.9	1.9	1.9	1.9	ns
t_{RW}	Reset Width	1.8	1.8	1.8	1.8	1.8	ns

Parameter	Description	Propagation Delays 1	2	3	4	6	8	Unit
INPUT CELLS								
t_{IN}	Input Delay (HIGH Drive)	2.1	2.2	2.3	2.4	2.6	2.9	ns
t_{INI}	Input, Inverting Delay (HIGH Drive)	2.1	2.2	2.3	2.5	2.8	3.1	ns
t_{IO}	Input Delay (Bidirectional Pad)	1.4	1.8	2.2	2.6	3.4	4.2	ns
t_{GCK}	Clock Buffer Delay[6]	2.7	2.7	2.8	2.9	3.0		ns
t_{GCKHI}	Clock Buffer Min. HIGH[6]	2.0	2.0	2.0	2.0	2.0		ns
t_{GCKLO}	Clock Buffer Min. LOW[6]	2.0	2.0	2.0	2.0	2.0		ns

Parameter	Description	Propagation Delays[4] with Output Load Capacitance (pF) of 30	50	75	100	150	Unit
OUTPUT CELLS							
t_{OUTLH}	Output Delay LOW to HIGH	2.7	3.4	4.2	5.0	6.7	ns
t_{OUTHL}	Output Delay HIGH to LOW	2.8	3.7	4.7	5.6	7.6	ns
t_{PZH}	Output Delay Three-State to HIGH	4.0	4.9	6.1	7.3	9.7	ns
t_{PZL}	Output Delay Three-State to LOW	3.6	4.2	5.0	5.8	7.3	ns
t_{PHZ}	Output Delay HIGH to Three-State[7]	2.9					ns
t_{PLZ}	Output Delay LOW to Three-State[7]	3.3					ns

Notes:

4. Worst-case propagation delay times over process variation at V_{CC} = 3.3V and T_A = 25°C. Multiply by the appropriate delay factor, K, for speed grade to get worst-case parameters over full V_{CC} and temperature range as specified in the operating range. All inputs are TTL with 3-ns linear transition time between 0 and 3 volts.
5. These limits are derived from worst-case values for a representative selection of the slowest paths through the pASIC380 logic cell including net delays. Guaranteed delay values for specific paths should be determined from simulation results.
6. Clock buffer fanout refers to the maximum number of flip-flops per half column. The number of half columns used does not affect clock buffer delay.
7. The following loads are used for t_{PXZ}:

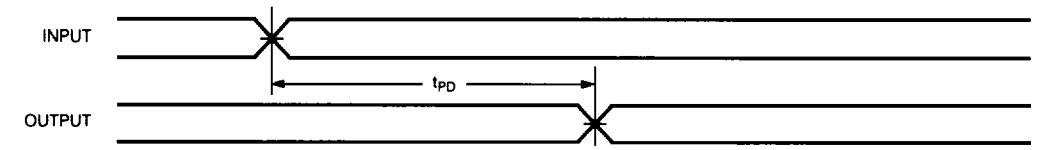


High Drive Buffer

Parameter	Description	# High Drives Wired Together	Propagation Delays[4] with Fanout of 12	24	48	72	96	Unit
t_{IN}	High Drive Input Delay	1	4.0	4.9				ns
		2		3.5	5.0			ns
		3			4.0	4.8	5.6	ns
		4				4.1	4.8	ns
t_{INI}	High Drive Input, Inverting Delay	1	4.2	5.1				ns
		2		3.7	5.2			ns
		3			4.2	5.0	5.8	ns
		4				4.3	5.0	ns

Switching Waveforms

Combinatorial Delay



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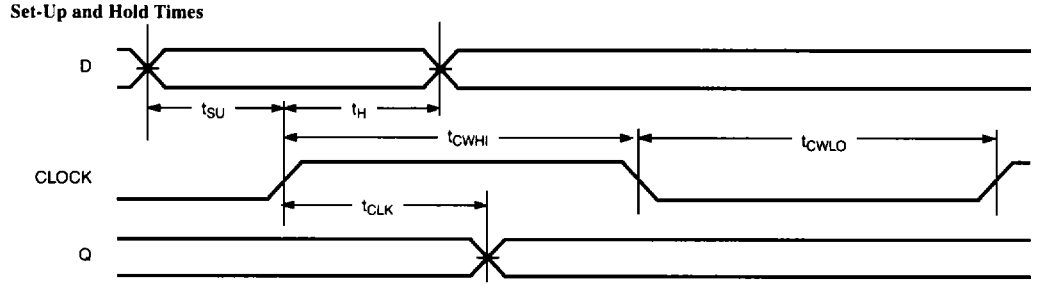
Set-Up and Hold Times



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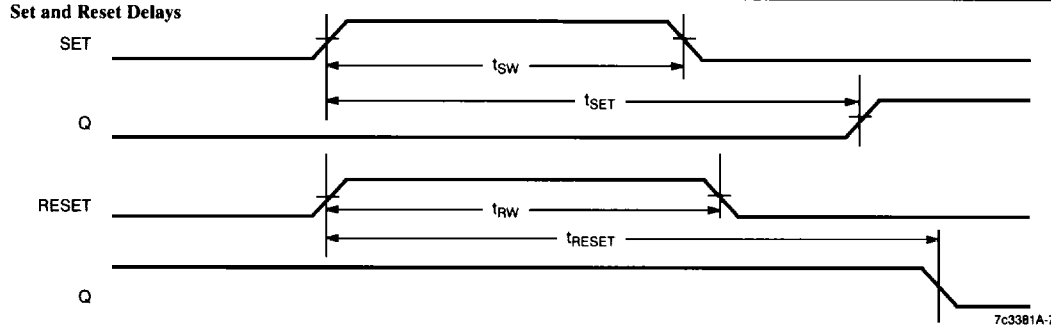
Set and Reset Delays



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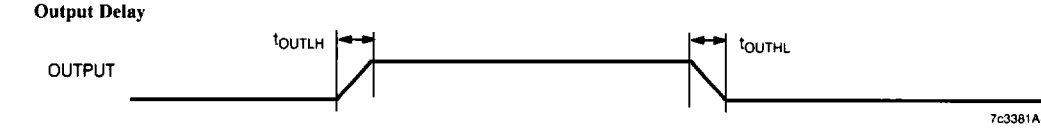
Output Delay



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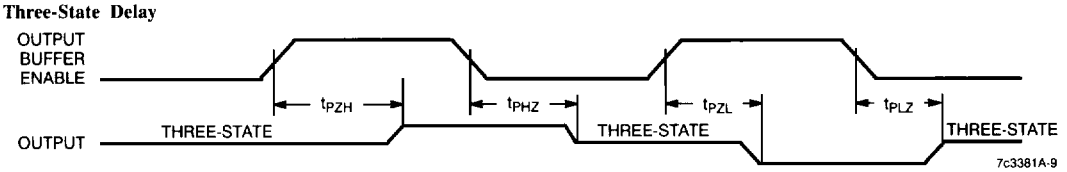
Switching Waveforms (continued)

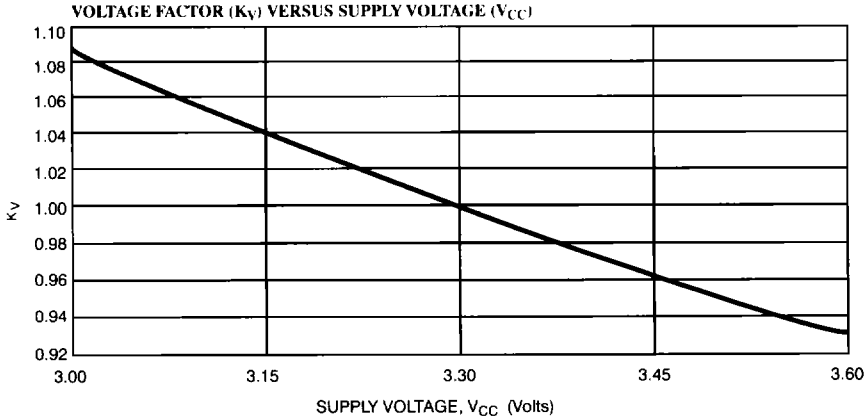
Three-State Delay



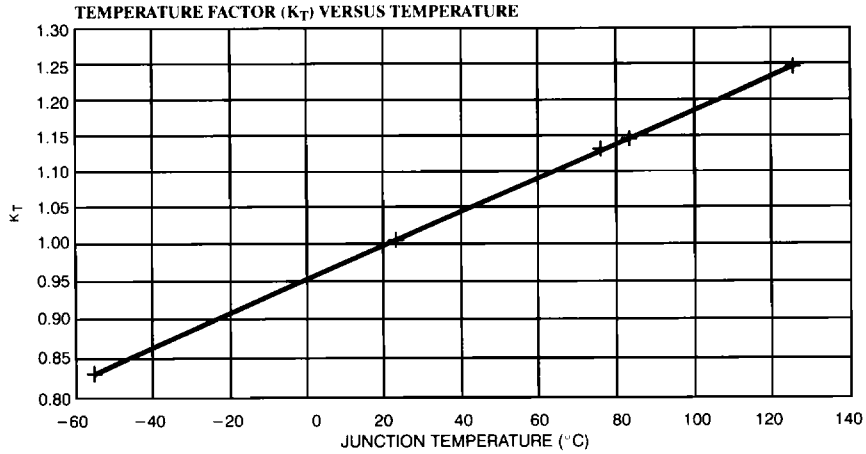
Typical AC Characteristics

Propagation delays depend on routing, fan-out, load capacitance, supply voltage, junction temperature, and process variation. The AC Characteristics are a design guide to provide initial timing estimates at nominal conditions. Worst-case estimates are obtained when nominal propagation delays are multiplied by the appropriate Delay Factor, K, as specified by the speed grade in the Delay Factor table. The effects of voltage and temperature variation are illustrated in the graphs below. The *Warp3* Delay Modeler extracts specific timing parameters for precise simulation results following place and route.

VOLTAGE FACTOR (K_V) VERSUS SUPPLY VOLTAGE (V_{CC})

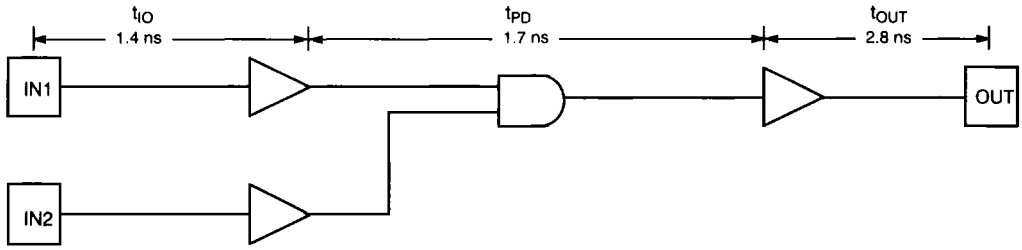


TEMPERATURE FACTOR (K_T) VERSUS TEMPERATURE



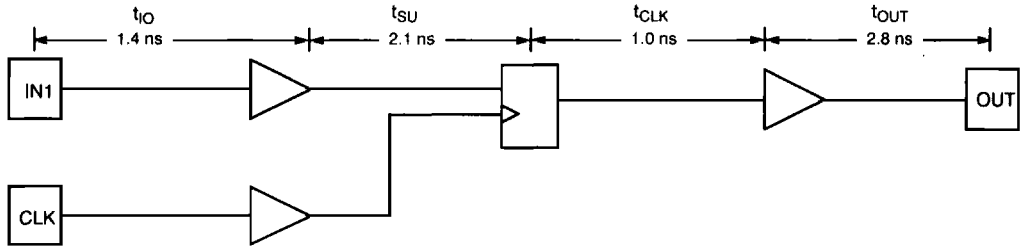
*THETA JA = 45 °C/WATT FOR PLCC

Combinatorial Delay Example (Load = 30 pF, K = 1, Fanout = 1)



INPUT DELAY + COMBINATORIAL DELAY + OUTPUT DELAY = 5.9 ns

Sequential Delay Example (Load = 30 pF, K = 1, Fanout = 1)



INPUT DELAY + REG SET-UP + CLOCK TO Q DELAY + OUTPUT DELAY = 7.3 ns

Ordering Information

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
1	CY7C3381A-1JC	J67	44-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C3381A-1JI	J67	44-Lead Plastic Leaded Chip Carrier	Industrial
0	CY7C3381A-0JC	J67	44-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C3381A-0JI	J67	44-Lead Plastic Leaded Chip Carrier	Industrial
X	CY7C3381A-XJC	J67	44-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C3381A-XJI	J67	44-Lead Plastic Leaded Chip Carrier	Industrial

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
1	CY7C3382A-1AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C3382A-1JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C3382A-1AI	A100	100-Pin Thin Quad Flat Pack	Industrial
	CY7C3382A-1JI	J81	68-Lead Plastic Leaded Chip Carrier	
0	CY7C3382A-0AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C3382A-0JC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C3382A-0AI	A100	100-Pin Thin Quad Flat Pack	Industrial
	CY7C3382A-0JI	J81	68-Lead Plastic Leaded Chip Carrier	
X	CY7C3382A-XAC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C3382A-XJC	J81	68-Lead Plastic Leaded Chip Carrier	
	CY7C3382A-XAI	A100	100-Pin Thin Quad Flat Pack	Industrial
	CY7C3382A-XJI	J81	68-Lead Plastic Leaded Chip Carrier	

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